

CMOS Digital Integrated Circuits Silicon Monolithic

T74VCXHR162245

1. Functional Description

· Low-Voltage 16-Bit Bus Transceiver with Bushold and Series Resistor

2. General

The T74VCXHR162245 is a high-performance CMOS 16-bit bus transceiver. Designed for use in 1.8 V, 2.5 V or 3.3 V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This 16-bit bus transceiver is controlled by direction control (DIR) inputs and output enable (\overline{OE}) inputs which are common to each byte. It can be used as two 8-bit transceivers or one 16-bit transceiver. The direction of data transmission is determined by the level of the DIR inputs. The \overline{OE} inputs can be used to disable the device so that the busses are effectively isolated.

The 26Ω series resistor helps reducing output overshoot and undershoot without external resistor.

The A, B data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating data inputs at a valid logic level.

All inputs are equipped with protection circuits against static discharge.

3. Features (Note)

- (1) Wide operating temperature range: $T_{opr} = -40$ to 125 °C (Note 1)
- (2) 26Ω series resistors on all outputs
- (3) Low-voltage operation: $V_{CC} = 1.8 \text{ to } 3.6 \text{ V}$
- (4) Bushold on data inputs eliminating the need for external pull-up, pull-down resistors
- (5) High-speed operation: $t_{pd} = 3.4 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$

$$t_{pd} = 4.3 \text{ ns (max) (V}_{CC} = 2.3 \text{ to } 2.7 \text{ V})$$

$$t_{pd} = 5.7 \text{ ns (max) (V}_{CC} = 1.8 \text{ V)}$$

(6) Output current: $I_{OH}/I_{OL} = \pm 12 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$

$$I_{OH}/I_{OL}$$
 = ±8 mA (min) (V_{CC} = 2.3 V)

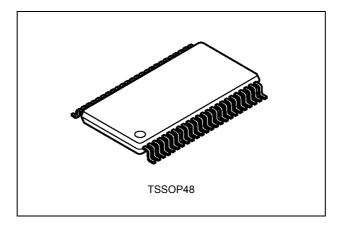
$$I_{OH}/I_{OL}$$
 = ±4 mA (min) (V_{CC} = 1.8 V)

(7) 3.6-V tolerant control inputs

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

4. Packaging

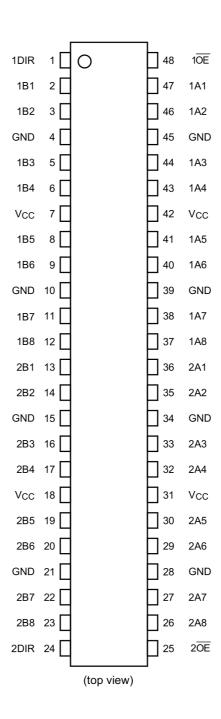


Start of commercial production

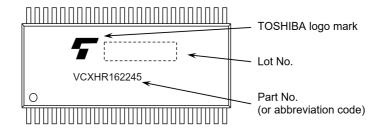
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5. Pin Assignment

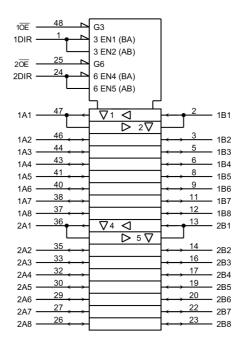


6. Marking





7. IEC Logic Symbol



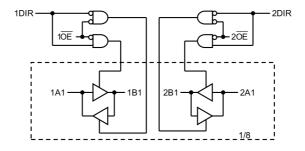
8. Truth Table

Inputs 1 <u>OE</u> 2OE	Inputs 1DIR 2DIR	Outputs	Function Bus 1A1-1A8 Bus 2A1-2A8	Function Bus 1B1-1B8 Bus 2B1-2B8
L	L	A = B	Output	Input
L	Н	B = A	Input	Output
Н	Х	Z	Z	Z

X: Don't care

Z: High impedance

9. System Diagram





10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 4.6	V
Input voltage (DIR/OE)	V _{IN}		-0.5 to 4.6	V
Bus I/O voltage	V _{I/O}	(Note 1)	-0.5 to V _{CC} + 0.5	V
		(Note 2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-50	mA
Output diode current	I _{OK}	(Note 3)	±50	mA
Output current	I _{OUT}		±50	mA
Power dissipation	P _D	(Note 4)	400	mW
V _{CC} /ground current (per supply pin)	I _{CC} /I _{GND}		±100	mA
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Output in OFF state.
- Note 2: High (H) or Low (L) state. I_{OUT} absolute maximum rating must be observed.
- Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$
- Note 4: 400 mW in the range of Ta = -40 to 85 $^{\circ}$ C. From Ta = 85 to 125 $^{\circ}$ C a derating factor of -6.25 mW/ $^{\circ}$ C shall be applied until 150 mW.

11. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		1.8 to 3.6	V
		(Note 1)	1.2 to 3.6	
Input voltage (DIR/OE)	V _{IN}		-0.3 to 3.6	V
Bus I/O voltage	V _{I/O}	(Note 2)	0 to V _{CC}	V
		(Note 3)	0 to V _{CC}	
Output current	I _{OH} ,I _{OL}	(Note 4)	±12	mA
		(Note 5)	±8	
		(Note 6)	±4	
Operating temperature	T _{opr}	(Note 7)	-40 to 125	°C
Input rise and fall times	dt/dv	(Note 8)	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note: Floating or unused control inputs must be held high or low.

Note 1: Data retention only.

Note 2: Output in OFF state.

Note 3: High (H) or Low (L) state.

Note 4: V_{CC} = 3.0 to 3.6 V

Note 5: V_{CC} = 2.3 to 2.7 V

Note 6: $V_{CC} = 1.8 \text{ V}$

Note 7: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

Note 8: V_{IN} = 0.8 to 2.0 V , V_{CC} = 3.0 V



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Note	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}		_		1.8 to 2.3	$V_{CC} \times 0.7$	_	V
					2.3 to 2.7	1.6	_	
					2.7 to 3.6	2.0	_	
Low-level input voltage	V _{IL}		_		1.8 to 2.3	_	$V_{CC} \times 0.2$	V
					2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}		V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.8 to 3.6	V _{CC} - 0.2	_	V
				I _{OH} = -4 mA	1.8	1.4	_	
					2.3	2.0	_	
				I _{OH} = -6 mA	2.3	1.8	_	
					2.7	2.2	_	
				I _{OH} = -8 mA	2.3	1.7	_	
					3.0	2.4	_	
				I _{OH} = -12 mA	3.0	2.2	_	
Low-level output voltage	V _{OL}		V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.8 to 3.6	_	0.2	V
				I _{OL} = 4 mA	1.8	_	0.3	
				I _{OL} = 6 mA	2.3	_	0.4	
					2.7	_	0.4	
				I _{OL} = 8 mA	2.3	_	0.6	
					3.0	_	0.55	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage current (DIR/OE)	I _{IN}		V _{IN} = 0 to 3.6 V	•	1.8 to 3.6	_	±5.0	μА
Bushold input minimum	I _{I(HOLD)}		V _{IN} = 0.36 V		1.8	25	_	μΑ
drive hold current			V _{IN} = 1.26 V		1.8	-25	_	
			V _{IN} = 0.7 V		2.3	45	_	
			V _{IN} = 1.6 V		2.3	-45	_	
			V _{IN} = 0.8 V		3.0	75	_	
			V _{IN} = 2.0 V		3.0	-75	_	
Bushold input over-drive	I _{I(OD)}	(Note 1)	$V_{IN} = L \rightarrow H$		1.8	_	200	μА
current to change state			$V_{IN} = H \rightarrow L$		1.8	_	-200	
			$V_{IN} = L \rightarrow H$		2.3	_	300	
			$V_{IN} = H \rightarrow L$		2.3	_	-300	
			$V_{IN} = L \rightarrow H$		3.6	_	500	
			$V_{IN} = H \rightarrow L$		3.6	_	-500	
3-state output OFF-state leakage current	I _{OZ}		$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.8 to 3.6	_	±10.0	
Quiescent supply current	Icc		V _{IN} = V _{CC} or GND)	1.8 to 3.6	_	20.0	μΑ
	Δl _{CC}		V _{IH} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	_	750	μА

Note 1: It is a necessary electric current to change the input in "L" or "H".



12.2. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Note	Test Condition	n	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}		_		1.8 to 2.3	V _{CC} × 0.7	_	V
					2.3 to 2.7	1.6	_	
					2.7 to 3.6	2.0	_	
Low-level input voltage	V _{IL}		_		1.8 to 2.3	_	$V_{CC} \times 0.2$	V
					2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}		$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -100 μA	1.8 to 3.6	V _{CC} - 0.2	_	V
				I _{OH} = -4 mA	1.8	1.4		
					2.3	2.0	_	
				I _{OH} = -6 mA	2.3	1.8	_	
					2.7	2.2	_	
				I _{OH} = -8 mA	2.3	1.7	_	
					3.0	2.4	_	
				I _{OH} = -12 mA	3.0	2.2	_	
Low-level output voltage	V _{OL}		V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.8 to 3.6	_	0.2	V
				I _{OL} = 4 mA	1.8	_	0.3	
				I _{OL} = 6 mA	2.3	_	0.4	
					2.7	_	0.4	
				I _{OL} = 8 mA	2.3	_	0.6	
					3.0	_	0.55	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage current (DIR/OE)	I _{IN}		V _{IN} = 0 to 3.6 V		1.8 to 3.6	_	±20.0	μА
Bushold input minimum	I _{I(HOLD)}		V _{IN} = 0.36 V		1.8	25	_	μА
drive hold current			V _{IN} = 1.26 V		1.8	-25	_	
			V _{IN} = 0.7 V		2.3	45	_	
			V _{IN} = 1.6 V		2.3	-45	_	
			V _{IN} = 0.8 V		3.0	75	_	
			V _{IN} = 2.0 V		3.0	-75	_	
Bushold input over-drive	I _{I(OD)}	(Note 1)	$V_{IN} = L \rightarrow H$		1.8	_	200	μА
current to change state			$V_{IN} = H \rightarrow L$		1.8	_	-200	
			$V_{IN} = L \rightarrow H$		2.3	_	300	
			$V_{IN} = H \rightarrow L$		2.3	_	-300	
			$V_{IN} = L \rightarrow H$		3.0	_	500	
			$V_{IN} = H \rightarrow L$		3.0	_	-500	
3-state output OFF-state leakage current	I _{OZ}		$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.8 to 3.6	_	±40.0	μА
Quiescent supply current	Icc		V _{IN} = V _{CC} or GNE		1.8 to 3.6	_	80.0	μА
	Δl _{CC}		V _{IH} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	_	1.5	mA

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

Note 1: It is a necessary electric current to change the input in "L" or "H".



12.3. AC Characteristics (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	5.7	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	2.5 ± 0.2	1.0	4.3	
			Table 12.0.1	3.3 ± 0.3	0.8	3.4	
3-state output enable time	t_{PZL}, t_{PZH}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	7.6	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	2.5 ± 0.2	1.0	5.7	
			Table 12.0.1	3.3 ± 0.3	0.8	4.2	
3-state output disable time	t_{PLZ}, t_{PHZ}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	5.7	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	2.5 ± 0.2	1.0	4.8	
			Table 12.0.1	3.3 ± 0.3	0.8	4.1	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	1.8 ± 0.15	_	0.5	ns
				2.5 ± 0.2	_	0.5	
				3.3 ± 0.3	_	0.5	

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$

12.4. AC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	6.8	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	2.5 ± 0.2	1.0	5.1	
			Table 12.0.1	3.3 ± 0.3	0.8	4.1	
3-state output enable time	t _{PZL} ,t _{PZH}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	9.0	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	2.5 ± 0.2	1.0	6.8	
			Table 12.6.1	3.3 ± 0.3	0.8	5.0	
3-state output disable time	t _{PLZ} ,t _{PHZ}		See 12.7 AC Test Circuit,	1.8 ± 0.15	1.5	6.8	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	2.5 ± 0.2	1.0	5.7	
			Table 12.6.1	3.3 ± 0.3	0.8	4.9	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	1.8 ± 0.15	_	1.0	ns
				2.5 ± 0.2	_	1.0	
				3.3 ± 0.3		1.0	

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m - t_{PLH}n|$, $t_{osHL} = |t_{PHL}m - t_{PHL}n|$)

12.5. Dynamic Switching Characteristics (Note) (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	0.15	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	0.25	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.35	
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	-0.15	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	-0.25	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	-0.35	
Quiet output minimum dynamic V _{OH}	V _{OHV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	1.55	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	2.5	2.05	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	2.65	

Note: Parameter guaranteed by design.

Rev.3.0



12.6. Capacitive Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}		_	1.8, 2.5, 3.3	6	pF
Bus I/O capacitance	C _{I/O}		_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	(Note 1)	f _{IN} = 10 MHz	1.8, 2.5, 3.3	20	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$$
 (per gate)

12.7. AC Test Circuit

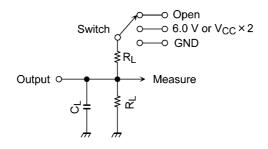


Table 12.7.1 Parameter for AC Test Circuit

Parameter	Switch	Test Condition
t _{PLH} , t _{PHL}	OPEN	_
t _{PLZ} , t _{PZL}	6.0 V	$V_{CC} = 3.3 \pm 0.3 \text{ V}$
	V _{CC} × 2	$V_{CC} = 2.5 \pm 0.2 \text{ V}$
		V _{CC} = 1.8 ± 0.15 V
t _{PHZ} , t _{PZH}	GND	_



12.8. AC Waveform

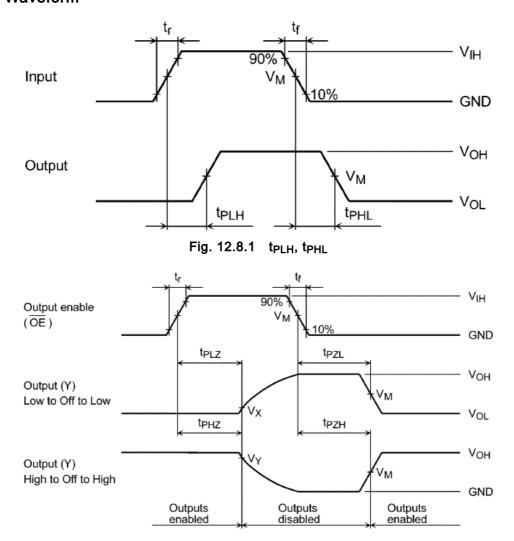


Fig. 12.8.2 t_{PLZ}, t_{PHZ}, t_{PZL}, t_{PZH}

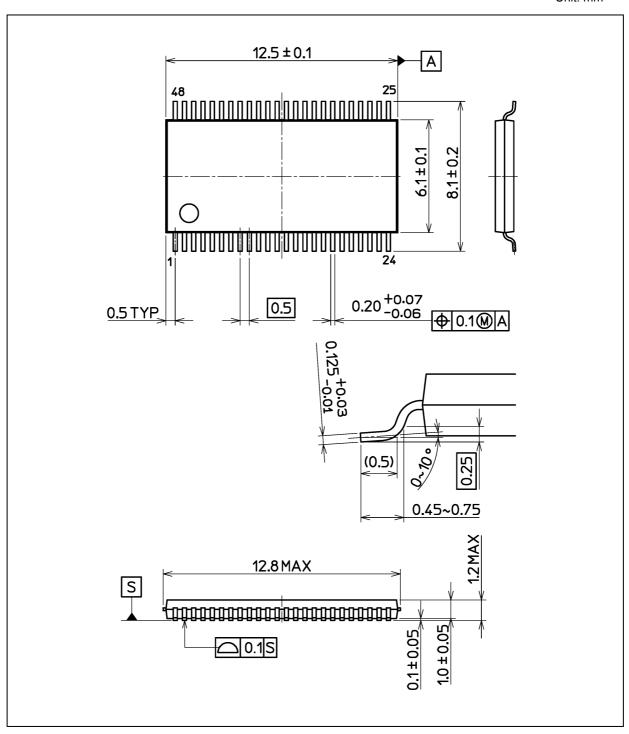
Table 12.8.1 AC Waveform Symbols

	Symbol	V_{CC} = 3.3 \pm 0.3 V	V_{CC} = 2.5 \pm 0.2 V	V_{CC} = 1.8 \pm 0.15 V
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	V_{M}	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.0 ns	2.0 ns	2.0 ns
Output	V_{M}	1.5 V	V _{CC} /2	V _{CC} /2
	V _X	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
	V_{Y}	V _{OH} - 0.3 V	V _{OH} - 0.15 V	V _{OH} - 0.15 V
Load	C_L	30 pF	30 pF	30 pF
	R_L	500 Ω	500 Ω	500 Ω



Package Dimensions

Unit: mm



Weight: 0.25 g (typ.)

Package Name(s)
Nickname: TSSOP48



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